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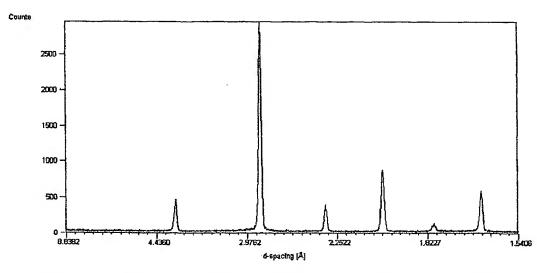
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## (54) Title: PRECURSOR SOLUTION, METHOD OF PREPARATION THEREOF AND USE THEREOF



(57) Abstract: Crystalline, single-phased layers of PbMg<sub>0.33</sub> Nb<sub>0.67</sub>0<sub>3</sub> with relative dielectric constants of 1500 and more are prepared through the use of a precursor solution that comprises a macrocyclic complexing agent. This agent is added to the lead component in an organic solution. The resulting layer is part of a device which may further include semiconductor elements and resistors.

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